Theory of traveling lam ents in bistable sem iconductor structures

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We present a generic nonlinear model for current lamentation in semiconductor structures with S-shaped current-voltage characteristics. The model accounts for Joule self-heating of a current density lament. It is shown that the self-heating leads to a bifurcation from static to traveling lament. Filaments start to travel when increase of the lattice temperature has negative impact on the cathode-anode transport. Since the impact ionization rate decreases with temperature, this occurs for a wide class of semiconductor systems whose bistability is due to the avalanche impact ionization. We develop an analytical theory of traveling laments which reveals the mechanism of lament motion, nd the condition for bifurcation to traveling lament, and determine the lament velocity.

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I. INTRODUCTION

Bistable semiconductor systems with S-shaped

current-voltage characteristics exhibit spontaneous formation of current density lam ents high current density domains in the low current density environm ent. 2,3,4,5,6 Current lam entation typically develops due to the spatial long wavelength instability known as Ridley instability of the uniform state with negative di erential conductance when the device is operated via su ciently large load resistance,7,8 Fig. 1. Form ation of current laments potentially leads to therm aldestruction of sem iconductor structure and thus is an important scenario of semiconductor device failure.4,6 Current lam ents have been studied in bulk semiconductors, 2,5,9,10 thin semiconductor $\mbox{lm} \ \mbox{s}_{\mbox{\tiny 1}}^{11,12,13,14,15} \ \mbox{and layered structures of sem iconduc-}$ tor devices. 16,17,18,19,20,21 Over last decade, the focus has been shifted from static lam ents to complex spatiotem poral dynamics of current density patterns. 22,23,24,25 Modern experimental techniques based on electron scanning microscopy, 26 detection of infrared radiation, 27 and interferom etric mapping28 provide means for direct observation of current density dynamics during lam entation. In regard to pattern formation and nonlinear phenomena, bistable semiconductors have much in common with other spatially distributed active media such as gas discharge systems, chemical and biological system s.^{22,29,30,31,32,33}

Apart from the well understood bifurcation which leads to temporal periodic or chaotic oscillations, ^{34,35,36,37} static lament may undergo a secondary bifurcation that leads to traveling lament. Lateral movement of laments along the device has been observed experimentally for dierent types of semiconductor structures. ^{27,28,38,39} Remarkably, in all

these structures the S-shaped characteristic is associated with avalanche impact ionization. Since impact ionization coe cients decrease with temperature, the onset of lament motion has been attributed to the self-heating of the lament! the lament is expected to migrate to a colder region as temperature at its initial location increases. When current lamentation is unavoidable, the migration is desirable in applications because the lament motion delocalizes the heating of the semiconductor structure and thus reduces the hazard of thermal destruction.

The purpose of this paper is to describe the mechanism of lament motion, to develop a generic nonlinear model for traveling lament, to nd the condition for bifurcation to traveling lament, and to determine the lament velocity. We demonstrate that the transition from static to traveling lament due to the Joule self-heating represents a generice ect which potentially appears in any bistable semiconductor structure provided that transport in the cathode-anode direction is sensitive to temperature.

II. MODEL OF A BISTABLE SEM ICONDUCTOR SYSTEM

For many semiconductors and semiconductor devices current lamentation can be described by a two-component reaction-di usion model which consists of a partial di erential equation for the bistable element and an integro-di erential Kirchho 's equation for the external circuit^{7,8,41}

$$\frac{e_{a}}{e_{t}} = r_{?} (D_{a}(a)r_{?}a) + f(a;u); r_{?} e_{x}e_{x} + e_{y}e_{y}; (1)$$

$$u \frac{du}{dt} = U_{0} \quad u \quad R \quad J(a;u)dxdy; \quad u \quad RC:(2)$$

Here the variable a (x; y; t) characterizes the internal state of the device and the variable u (t) is the voltage over the device, U_0 is the total applied voltage, J is the current density, R is the load resistance connected in series with the device, C is the e ective capacitance of the device and the external circuit, and S is the device cross-section (Fig. 1). The local kinetic function f (a; u) and the J (a; u) dependence contain all inform ation about transport in the cathode-anode (vertical) direction; the di usion coe cient Da (a) characterizes lateral coupling in the spatially extended element. In the bistability range u_h < u < u_{th} (see Fig. 1) the local kinetic function f (a;u) has three zeros ao; aint; aon corresponding to o , intermediate, and on branches of current voltage characteristic. It has one zero outside the bistability range. For the hom ogeneous state, the local dependence a(u) is calculated from f(a;u) = 0, and then inserted into J (a; u) in order to determ ine the local current-voltage characteristic J (u) J(a(u);u). Typically $Q_{11}f_{12}Q_{21}f_{13}Q_{21}f_{13} > 0$. The model (1), (2) belongs to a class of activator-inhibitor models with global inhibition. 25 Variables a and u serve as activator and inhibitor, respectively. The time scale of the activator a is $a = Q_a f^{-1}$? Speci c functional form s f(a; u), j(a; u), and D a (a) have been derived for various sem iconductors and sem iconductor structures. 2,7,8,9,10,17,18,20,34,41,42 The physical meaning of a depends on the particular type of bistable structure: a corresponds to the bias of the em itter p-n junction for avalanche transistors, 18 thyristors 20 and thyristorlike structures, interface charge for heterostructure hot electron diode,³⁴ electron charge stored in the quantum well for bistable double barrier resonant tunneling diode, 41,42 etc.

The two-component model (1), (2) is capable to describe steady lam ents as well as tem poraloscillation of current density lam ents. However, its solutions do not include traveling lam ents.

The self-heating of the lam ent has an impact on am ent dynam ics when vertical transport is sensitive to tem perature. In term s of Eq. (1) it means that the local kinetic function f depends on the lattice temperature T. We get $Q_T f < 0$ when temperature suppresses the vertical transport. Since the therm aldi usion length 1 is typically much larger than the device width w, the heat dynam ics in the device can be modelled by the twodim ensional equation

$$C W \frac{QT}{Qt} = W ? T + Ju (T T_{ext}); (3)$$

Here T corresponds to the mean value of temperature along the device vertical direction, c, , and are speci c heat, density, and heat conductivity of the sem iconductor m aterial, respectively. The second and the third term son the right-hand side of Eq. (3) describe Joule heating and cooling due to contact with environment, respectively. T_{ext} is the tem perature of the external cooling reservoir. For multilayer structures with classical transport, Text

is usually a room temperature. The coe cient heat transfer coe cient (per unit square of the structure) that characterizes the e ciency of external cooling. The characteristic relaxation time $_{\mathrm{T}}$, di usion length $_{\mathrm{T}}$, and propagation velocity v_T are given by

$$_{T}$$
 $\stackrel{CW}{\longrightarrow}$; $_{T}$ $\stackrel{r}{\longrightarrow}$; $_{V_{T}}$ $\stackrel{'_{T}}{\longrightarrow}$ = $_{C^{2}}^{2}$ $\stackrel{W}{\longrightarrow}$: (4)

The modi ed model is given by the following set of equations:

$$\frac{\partial a}{\partial t} = r_? (D_a(a)r_?a) + f(a;u;T);$$
 (5)

$$T = \frac{QT}{Qt} = \frac{V^2}{T} ? T + Ju = + T_{ext} T;$$
 (6)

$$T = \frac{\theta T}{\theta t} = \frac{Q}{T} ? T + Ju = + T_{ext} T; \qquad (6)$$

$$u \frac{du}{dt} = U_0 \qquad u \qquad R \qquad J (a; u; T) dxdy; \qquad (7)$$

The variable T plays a role of the second inhibitor.

In the following we assume that the device is elongated along the x direction (L_x L_v) and take only this lateral dim ension into account. We also neglect direct e ect of tem perature on the current density J in Eq. (7).

III. CURRENT FILAM ENT AND MECHANISM OF ITS M OTION

Current density lam ent in a long structure represents a dom ain of the high current density state em bedded into a low current density state (Fig. 2). The width of the $D_a = Q_a f^{.7}$ For lam ent wall 's is of the order of 's T = T_{ext} the voltage u_{co} over the device with steady lam ent is chosen by the condition known as \equalarea rule"^{2,5}

$$Z_{a_{on}}$$
 f (a; u_{co} ; $T = T_{ext}$) D_a (a) $da = 0$; (8)

which ensures that production and annihilation of the inhibitor a in the lam ent wall compensate each other. When the integral in (8) is positive or negative, the balance is broken, and the lam ent walls move in such a way that the high current density state or the low current density state, respectively, expand. Since $Q_u f > 0$, the lam ent expands for $u > u_{co}$ and shrinks for $u < u_{co}$. The lam ent has neutral stability with respect to the lateral shift when T is kept constant.8

The current-voltage characteristic of the long structure is practically vertical, 5,8,41 and bends in the upper and lower parts when the lament becom es narrow (Fig. 1). The bent parts correspond to current density intervals [J_o ;J_o + ('_f=L_x)J_{on}] and $(f=L_x)J_{on};J_{on}]$, where J_{on} and J_{o} are current densities in the high current density state and the low current density state, respectively. These intervals are negligible for L_x

The current lam ent is stable for su ciently large load resistance R and small relaxation time 1, 8,10 We assume

that $_{\rm u}$ $_{\rm a}$; $_{\rm T}$, and hence Eq. (7) essentially represents a constraint in posed on the dynam ics determ ined by Eqs. (5), (6). W ithout loss of generality we can also assume that the regime of the external circuit is close to the current-controlled regime: $U_0 = u_{co}$ and the total current I U_0 =R is constant. The width of the lament is directly proportional to the total current I

$$W = \frac{1}{L_{y}} \frac{I \quad L_{x}L_{y} \quad J}{J_{on} \quad J_{o}} \quad \frac{1}{L_{y}} \frac{I}{J_{on}}; \qquad (9)$$

where the last equality takes into account that typically $J_{\rm on} - J_{\rm o}$.

Qualitatively, the mechanism of the lament motions in presence of self-heating is the following. With increase of temperature the stationary balance (8) within the lament wall is broken due to the temperature dependence of the local kinetic function f(a;u;T). As far as the temperature pro le T(x) is symmetric, the left and right walls of the lament are equal and lament would either expand or shrink. This is forbidden since the total current is conserved by the global constraint (7). Increase of temperature is compensated by deviation of u from u_{∞} in such a way that the stationary balance within the

lam ent wall is restored. Since $Q_t f > 0$ and $Q_T f < 0$, the voltage increases, but the lam ent stays steady. In contrast, for antisym metric temperature uctuation the balance is disturbed dierently in the left and right lam ent walls, becoming positive at one side and negative at another side. Potentially, this spontaneous instability leads to them otion of a lam ent as a whole preserving the total current. In the traveling lam ent the temperature at the back edge exceeds the temperature at the leading edge due to the heat inertia of the semiconductor structure. Hence the lam ent motion becomes self-sustained.

Below we present an analytical theory of this e ect. The theory is based on the following assumptions:

(i) the e ect of self-heating is small and can be considered as a perturbation, hence the local kinetic function can be linearized near T = $T_{\rm ext}$ and u = $u_{\rm co}$ as

$$f(a;u;T) = f(a;u_{co};T = T_{ext})$$
 (10)
+ $(u \quad u_{co}) Q_u f + (T \quad T_{ext}) Q_T f;$

(ii) the transverse dimension of the sem iconductor structure is large in the sense that L_x ' $_f$;' $_T$, therefore only wide laments with W $_f$ are relevant and the e ect of boundaries is negligible;

(iii) the width of the $\,$ lam ent wall $_{\rm T}^{\, \rm c}$ is much smaller than the thermaldi usion length $_{\rm T}^{\, \rm c}$ and therefore the temperature variation within the $\,$ lam ent walls can be neglected.

IV. STATIONARY MOTION OF A FILAMENT: GENERAL PROPERTIES

A. Model equations in the co-moving frame

For stationary motion of a lament with a constant velocity v the solution of Eqs. (5), (7), (6) has a form:

$$a(x;t) = a(x vt); T(x;t) = T(x vt); u = const:(11)$$

In the co-m oving fram e = x vt, Eqs. 5), (7), (6) are

$$(D_a(a)a^0)^0 + va^0 + f(a;u;T) = 0;$$
 (12)

$$_{\text{T}}^{2}$$
 T 0 + v $_{\text{T}}$ T 0 + Ju= + T $_{\text{ext}}$ T = 0; (13)

$$U_0 u R I_y h J (a; u) i = 0:$$
 (14)

Here the prime $(:::)^0$ denotes the derivative with respect to and angular brackets h::i denote integration over . For the su-ciently large L_x the boundary conditions are given by

$$a()! a_o (u); T()! T_? for ! 1; (15)$$

w here

$$T_{?}$$
 $T_{ext} + J_{o}$ $(u_{co})u_{co} =$ (16)

is the stationary temperature corresponding to the low current density state.

B. Filam ent velocity and voltage over the structure

In order to calculate the velocity of the $\,$ lam ent and the voltage on the structure with traveling $\,$ lam ent, we note that for given u and T both $\,$ lam ent walls can be treated as propagating fronts in bistable medium and use the standard form ula^{25,31,41} $\,$

$$v = \frac{2^{R_{a_{on}}} f(a;u;T) D_{a}(a) da}{hD_{a}(a) (a_{0}^{0})^{2} i};$$
 (17)

where the lament pro le is approximated by the stationary pro le a (x). Eq. (17) implies that the velocity v is proportional to the disbalance of production and annihilation of the activator a in the lament wall. Here T is the temperature within the lament wall under consideration, which is taken as constant according to the assumption 'f'. The factor 2 in the nominator appears because a_0 corresponds to the pattern that consists of two fronts. Positive and negative velocities correspond to the propagation of the high current density state into the low current density state and vice versa, respectively.

Linearizing the local kinetic function according to Eq. (10) and taking into account Eq. (8), we obtain

$$v(u;T) = \frac{2}{hD_{a}(a)(a_{0}^{0})^{2}i}$$

$$Z_{a_{on}}$$

$$(u \quad u_{o}) Q_{u}f + (T \quad T_{ext}) Q_{T}f D_{a}(a) da:$$

$$a_{off}$$
(18)

Hereafter, all derivatives are taken at $u = u_{co}$ and T =Text.

Equation (18) should be applied separately to the left and the right lament walls. In terms of Eq. 18) the respective velocities have the same absolute value but di erent signs

$$v(u;T_R) = v(u;T_L);$$
 (19)

where $T_{\text{R}}\,$ and $T_{\text{L}}\,$ are temperatures at the right and the left walls, respectively. Equations (18) and (19) yield together

$$v = \frac{T_R}{hD_a(a) (a_0^0)^2 i} \sum_{a_{on}}^{Z_{a_{on}}} \theta_T f D_a(a) da; \qquad (20)$$

$$u = u_{co} + B = \frac{T_{L} + T_{R}}{2} = T_{ext}$$
; (21)
 $R_{a_{on}} e_{T} f D_{a}$ (a) da

$$\begin{array}{cccc}
R_{a_{on}} & Q_{T} & f D_{a} & (a) & da \\
R_{a_{on}}^{a_{off}} & Q_{u} & f D_{a} & (a) & da \\
\end{array}$$

$$\vdots$$

According to Eqs. (20), (21) the lam ent velocity is proportional to the di erence of tem peratures at the lam ent edges ($T_{T_{i}}$ T_R), while the voltage deviation from u_{co} is proportional to the m ean value $(T_L + T_R) = 2$. For $\theta_T f < 0$ the coe cient B is positive, and hence the voltage increases with the increase of temperature. The lament m oves to the right (v > 0) when $T_L > T_R$ and to the left (v < 0) when $T_{\rm L}$ < $T_{\rm R}$.

It is worth to mention that formula (20) derived for the wide lam ent with narrow walls is a special case of the general expression

$$v = \frac{h\theta_T f D_a (a) T () a_0^0 i}{h D_a (a) (a_0^0)^2 i};$$
 (22)

which is applicable for any lam ent shape and tem perature pro le T () satisfying the boundary condition 15). Similar to Eq. (17), equation (22) can be obtained by multiplying Eq. (12) by D_a (a)a⁰, integrating over and using the expansion (10).

Eqs. (20), (21) do not refer exclusively to the case of Joule self-heating. They are applicable regardless of the origin of the inhomogeneous temperature pro le in the sem iconductor structure. We conclude that when temperature suppresses the vertical transport $(e_T f < 0)$, as it happens in case of impact ionization mechanism of Stype characteristic, the lam ent generally m oves against the tem perature gradient. In the case when the in uence of heating is positive $(e_T f > 0)$, as it happens, for exam ple, when the therm openeration mechanism is involved, the lam ent m oves along the tem perature gradient.

C. Tem perature pro le in the moving lament

For a lament with narrow walls (; $_{T}$) the heat equation (13) is piecewise linear and the temperature pro le T () can be found analytically (see Appendix). Consequently, the temperatures $T_{\rm L}$ and $T_{\rm R}$ can be presented explicitly as functions of the lament velocity v and width W . It is convenient to introduce the norm alized di erence and the sum of $T_{\!\scriptscriptstyle L}$ and $T_{\scriptscriptstyle R}$:

$$_{LR} = \frac{T_L}{T?} \frac{T_R}{T?};$$
 $_{LR} = \frac{T_L + T_R}{T?} \frac{2T_?}{T?};$ (23)

where the tem peratures T $^{?}$ and T $_{?}$ are stationary uniform solutions of the heat equation (6) corresponding to uniform on and o states, respectively.43

$$T^{?} = T_{ext} + J_{on} (u_{co}) u_{co} = ;$$
 (24)

and T_2 is de ned by Eq. (16). Typically T_2 From the solution (A 2) of the heat equation we obtain

w here

$$\mathbf{v} = \frac{\mathbf{v}}{2\mathbf{v}_{\mathrm{T}}}; \quad \mathbf{w} = \frac{\mathbf{w}}{\mathbf{v}_{\mathrm{T}}}:$$

The dependencies $\ _{\text{LR}}$ (v;W) and $\ _{\text{LR}}$ (v;W) are shown in Fig. 3. The tem perature di erence is equal to zero for v = 0, when the tem perature pro le is sym m etric, and reaches maximum at a certain value of v Fig. 3(a)]. The tem perature di erence decreases with further increase of v and vanishes for large velocities (v $W = _{T}$) when the

lam ent m oves too fast to heat the sem iconductor structure. The average temperature and, according to Eq. (21), the voltage u m onotonically decrease as v increases Fig. 3 (b)]. Hence the onset of lam ent motion is always accompanied by a certain voltage drop. Both (TL and $(T_L + T_R)$ increase with lament width W for a given

V. SELF-CONSISTENT DETERM INATION OF FILAM ENT VELOCITY

In the regime of Joule self-heating, the stationary 1ament motion with a certain velocity occurs when the moving lament generates the temperature pro le with the temperature di erence (L T_R) which is exactly needed to support this motion. Combining Eqs. (20), (23), and (25), we obtain a transcendental equation for the lam ent velocity v:

$$\frac{\mathbf{v}}{\mathbf{v}_0} = \mathbf{L}_{\mathbf{R}} (\mathbf{v}; \mathbf{W}); \tag{27}$$

$$\frac{v}{v_0} = \sum_{LR} (v; W); \qquad (27)$$

$$v_0 = \frac{T^2 T_2}{h D_a (a) (a_0^0)^2 i} \sum_{a_{off}}^{a_{on}} \theta_T f D_a (a) da: \qquad (28)$$

Here v_0 is the upper lim it of the $\,$ lam ent velocity which is achieved for T_L $\,$ T_R = $T^{\,2}$ $\,$ T_2 . This velocity characterizes the e $\,$ ect of tem perature on the $\,$ lam ent dynam ics. The function $\,$ $\,$ LR is explicitly given by Eq. (25). $\,$ LR is odd with respect to v, re ecting the sym metry between left and right directions of the $\,$ lam ent motion. Hence nontrivial solutions v^2 6 0 of Eq. (27) always come in pairs (v^2; $\,$ v^2). Having this in mind, below we discuss only nonnegative solutions v $\,$ 0. Note that v_0 < 0 for e_T f > 0 (positive in uence of temperature on vertical transport), and therefore Eq. (28) has only trivial solution v = 0: $\,$ lam ent motion is not possible. We shall focus on the case e_T f < 0 when v_0 > 0.

It is im m ediately evident from Fig. 3(a) that Eq. (27) has either one or two nonnegative roots depending on v_0 and W . Solution $v^2=0$, corresponding to a steady lament, exists for all parameter values. Nontrivial solution $v^2>0$, that corresponds to the traveling lament, exists if

$$v_0 \frac{d_{LR}}{dv} > 1$$
: (29)

When the root v=0 is unique, the corresponding stationary lament is stable because $_{L\,R}$ $(v) < v=v_0$ for v>0. This inequality means that traveling lament generates a temperature dierence (I_L-I_R) which is not sufcient to support its motion. The situation changes when the condition (29) is met: in this case $_{L\,R}$ $(v) > v=v_0$ for v>0, and the steady solution is unstable. It means that the steady lament looses stability simultaneously with appearance of the nontrivial solution $v^2>0$ which corresponds to traveling lament. Hence, Eq. (29) represents a condition for spontaneous onset of the lament motion. We discuss the bifurcation from static to traveling lament in more details in the next section.

Traveling lament is stable because $_{L\,R}$ (v) > v=v_0 for v < v² and $_{L\,R}$ (v) < v=v_0 for v > v². Indeed, these inequalities mean that if v decreases the tem perature difference (T_L T_R) increases and hence according to (20) the lament velocity should increase again. In the same way, with increase of v the dierence (T_L T_R) decreases and therefore the lament slows down.

In Fig. 4(a) we present numerical solutions v(W) of Eq. (27) for dierent values of the parameter v(W). For a given v(W) the motion is possible for laments whose width exceeds a certain threshold v(W) (Fig. 5). With increase of v(W) the lament velocity increases and eventually saturates. We discuss the analytical approximations of the front velocity in Sec. V III.

In Fig. 4(b) we present the voltage u in the regime of current—lam entation obtained by substituting num erical solutions of Eq. (27) into Eqs. (21), (26). The normalized deviation of u from u_{CO}

$$\mathbf{e} = 2 \frac{B^{-1} (u - u_{co}) - (T_? - T_{ext})}{T^? - T_?}$$
 (30)

is shown, where B is determined by Eq. (21). The voltage drop, clearly visible on curves $2\{7$, is associated with the

onset of lam ent motion. W ith further increase of W the voltage increases again. Curve 1 is calculated for $v_0 = v_T = 2:1$, which is close to the threshold value $v_0 = v_T = 2$, and practically coincides with the curve for a static lam ent. Since the lam ent width W is directly proportional to the total current I [see Eq. (9)], Fig. 4 (b) actually represents the current-voltage characteristic of the structure with traveling lam ent.

VI. ONSET OF THE FILAM ENT MOTION

To analyze the onset of lam ent m otion and propagation of slow lam ents we expand $_{\rm L\,R}$ with respect to $v=v_{\rm T}$ up to the second order:

$$L_{R} (v; W) = \frac{v}{2v_{T}} + 1 + \frac{1}{8} + \frac{v}{v_{T}} + \frac{v}{2} + \frac{v}{2} + \frac{v}{2}$$

$$A (W) = 1 + \frac{W}{2} + \exp(-\frac{W}{2}) + \frac{v}{2} +$$

In this case the temperature pro le is close to the symmetric stationary pro le given by Eq. \mathbb{A} .4).

Substituting Eq. (31) in Eq. (29), we obtain an explicit condition for the onset of lament motion

$$\frac{v_0}{2v_T}A(W) > 1$$
: (32)

This condition can be further simpli ed for narrow and wide laments:

$$\frac{\mathbf{v}_0}{4\mathbf{v}_T} \quad \frac{\mathbf{W}}{\mathbf{v}_T} \quad ^2 > 1 \quad \text{for } \mathbf{W} \quad \mathbf{v}_T; \quad (33)$$

$$\frac{v_0}{2ev_T} \quad \frac{W}{T} + e \quad 3 > 1 \quad \text{for } W \qquad T; \qquad (34)$$

$$\frac{\mathbf{v}_0}{2\mathbf{v}_T} > 1 \quad \text{for } \mathbf{W} \qquad \mathbf{T} ; \qquad (35)$$

where e is the natural logarithm ic base. Since A (W) < 1, it follows from Eq. (32) that regardless to the lament width W the lament motion is not possible if $v_{\rm N} < 2v_{\rm T}$. If $v_{\rm O} > 2v_{\rm T}$, the laments whose width W overcomes the threshold W $_{\rm th}$ determined by Eq. (32) start to move, whereas smaller laments remain steady. The dependence of W $_{\rm th}$ on $v_{\rm O}{=}v_{\rm T}$ is shown in Fig. 5, curve 1. This dependence can be approximated as

$$W_{th}$$
 $2\frac{r}{T}\frac{\overline{v_T}}{v_0}$ for W_{th} r_T ; (36)

$$W_{th}$$
 $\frac{1}{T}$ $2e\frac{V_T}{V_0} + 3$ e for W_{th} $\frac{1}{T}$; (37)

W _{th}
$$^{\prime}$$
 In 1 $\frac{2v_{T}}{v_{0}}$ for W _{th} $^{\prime}$: (38)

The bifurcation to traveling lam ent resembles a supercritical pitchfork bifurcation: 44 at the bifurcation point W = W th the static solution becomes unstable and

simultaneously two stable branches corresponding to the lam ents traveling to the left and to the right appear Fig. 4(a)]. This bifurcation can be understood in terms of stability analysis of the current lam ent perform ed in Ref. 8 for standard two-component model (1), (2): The spectrum of eigenmodes of a static lament includes a neutralmode $_{T}$ with zero eigenvalue $_{T}$ = 0 which corresponds to translation. Existence of this neutral mode re ects the translation invariance of a static lam ent on a large spatial dom ain. In the extended model (5), (6), (7) the bifurcation to traveling lam ent is characterized by sym metry breaking when T becomes positive. This becom espossible due to the coupling between the master equation (5) and the heat equation (6) when $Q_T f < 0$. Note that for $Q_T f > 0$ the eigenvalue of the translation mode T becomes negative. This corresponds to selfpinning of the lam ent.

VII. PROPAGATION OF SLOW FILAMENTS

Substituting Eq. (31) into Eq. (27) we obtain an explicit equation for the lament velocity which is applicable for slow fronts:

$$v(W) = 2v_T - \frac{v_0}{v_T} A(W) - 2;$$
 (39)

where A (W) is de ned in Eq. (31). The asym ptotic value is given by

$$v ! 2v_T \frac{r}{v_0} = 2$$
 for $\frac{W}{v_T} ! 1 :$ (40)

Eq. (39) approxim ates v(W) with an accuracy of 10% up to the parameter value $v_0 = v_T = 3$ [curve 2 on Fig. 4(a)], despite it is derived for v_T : This wide range of applicability is due to particularly smooth behavior of v_T : to the left of its peak value [see Fig. 3(a)].

VIII. PROPAGATION OF FAST FILAM ENTS

In the lim it $v = v_T$ the temperature prole is strongly asymmetric [see Eq. (A.5)], and the temperature at the leading edge is close to $T_?$. The expression (25) can be expanded with respect to $v_T = v$:

$$_{LR}$$
 $(v; W) = 1$ $\exp \frac{W}{v_T}$ (41)
$$\frac{v_T}{v} \stackrel{2}{=} 2 \exp \frac{W}{v_T} :$$

A coording to Eq. (A 3) the characteristic scale of the tem – perature pro le for the fast lament is determined by ($^+$) 1 v_T which exceeds $^{\text{t}}_{\text{T}}$. To keep the di usion correction, we expand up to the second order.

A nalytical results are available for the case of a narrow lam ent (W $\,$ v $_T$) and a wide $\,$ lam ent (W $\,$ v $_T$).

In the rst case (W v_T) the tem perature inside the lam ent increases linearly, and T_L is much smaller than T^2 . For W = v_T 1, equation (41) reduces to

$$_{LR}$$
 (v;W) $\frac{W}{Y_{T}}$ $\frac{V_{T}}{V}$ $\frac{V_{T}}{V}$ $\frac{V_{T}}{V}$: (42)

Substituting (42) into Eq. (27) we obtain the lament velocity

$$v(W)$$
 $\frac{r}{\frac{W V_0}{T}} = \frac{V_T V_T}{2W}$ for $W V_T$: (43)

Note that in Eq. (43) the leading term does not depend on the heat di usion.

In the case of wide $\,$ lam ent (W $\,$ v $_{\rm T}$) the tem perature at the back edge is close the maximum value T $^{?}$. The front velocity is approximated by

$$v(W)$$
 $v_0 = \frac{2v_T^2}{v_0} = \exp -\frac{W}{v_{0-T}} = v_0 = \frac{2v_T^2}{v_0}$ (44)

and saturates at

$$v \; ! \; v_0 = \frac{2v_T^2}{v_0}$$
 for $\frac{W}{v_{0 \; T}} \; ! \; 1 \; :$

IX . D ISC U SS IO N

A . Scales hierarchy - which lim iting case is relevant?

The therm al relaxation time $_{\rm T}$ of the sem iconductor structure can be straightforwardly determ ined in experiment. Therefore it is convenient to use it as basic parameter and to express $^{\rm t}_{\rm T}$ and $v_{\rm T}$ via $_{\rm T}$. Depending on the structure width and design, the electric value of $_{\rm T}$ varies from 100-200 ns for transistorlike structures of electrostatic discharge protections devices 39 (the structure width w 10 m) to 10-100 m s for power devices (the structure width w 100-500 m) 40 . It follows from Eq. (4) that parameters $^{\rm t}_{\rm T}$ and $v_{\rm T}$ are connected to $_{\rm T}$ via

$$v_T = p \frac{}{D_T}; \quad v_T = \frac{r}{\frac{}{D_T}}; \quad D_T = \frac{}{c}; \quad (45)$$

where the thermal di usivity D_T depends only on material parameters. We take $D_T=0.92\,\mathrm{cm}^2=\mathrm{s}$ and $D_T=0.25\,\mathrm{cm}^2=\mathrm{s}$ for Si and GaAs, respectively. Consequently, 'T and V_T are of the order of 100 m and $10^3\,\mathrm{cm}=\mathrm{s}$, respectively, for small devices (T 100 ns, w 10 m). We obtain 1 mm and 10 cm/s, respectively, for large power devices (T 10 ms, w 100 m). Hence in most devices the lament width W is of the order of the thermal di usion length 'T or smaller, and 'T is smaller but comparable to the transverse dimension of the structure L. In particular, it implies that in the regime of

self-heating the m axim um tem perature in the current lam ent is much smaller than T?. For W $^{<}$'s and su ciently far from the bifurcation point $v_0=2v_T$ the lam ent velocity is well described by the form u.la (43), where the second term can be neglected.

B. Stim ulating the lam ent motion

M otion of the lam ent delocalizes heating of sem iconductor structure and thus is desirable in applications. Generally, the start of the lam ent m otion becomes easier with increase of v_0 and decrease of v_T and v_T (see Eq. (32) and Fig. 5, curve 1). However, these parameters cannot be varied independently. Below we focus on the elect of the structure parameters which enter our model: the heat transfer coelicient and the structure width w.

Curve 2 in Fig. 5 shows the threshold lament width W $_{\rm th}$ normalized by the quantity (D $_{\rm T}^2$ T = v_0)¹⁼³ which does not depend on the heat transfer coe cient . Taking into account that $v_{\rm T}$ = v_0 $^{3=2}$, we conclude that decrease of makes the onset of the lament motion easier. This occurs due to the increase of v_0 which, according to Eqs. (16), (24), (28), scales as v_0 1 . However, easy start of the lament motion in structures with ine cient cooling comes at the price of increasing the temperature in the lament, which makes static laments more dangerous.

Curve 3 in Fig. 5 shows W $_{\rm th}$ normalized by the quantity (D $_{\rm T}$ =v $_{\rm 0}$) $^{1=2}$ which does not depend on w . Since v $_{\rm T}$ =v $_{\rm 0}$ w $^{1=2}$, we see that the dependence of W $_{\rm th}$ on w is nonmonotonic. Physically relevant situation W $^{<}$ v $_{\rm T}$ corresponds to the left part of the curve 3 where W $_{\rm th}$ increases with w . Thee ect is due to increase of $^{\circ}_{\rm T}$ w $^{1=2}$. Thus, for the xed value of v, thinner structures are preferable for the lam ent motion .

C. Transient behavior

Static current lament typically appears due to the spatial instability of the uniform state on the middle branch of current-voltage characteristic (see Fig. 1). This occurs on the time scale $_{\rm a}$ which is typically smaller than the thermal time scale $_{\rm T}$. First the voltage settles at u = u_{\rm co}, and only then the temperature starts to increase. A coording to Eq. (21) the Joule heating is accompanied by increase of u. As soon as the static lament gets hot, the bifurcation to the traveling lament occurs, provided that the condition (29) is satis ed. The onset of

lam ent m otion leads to a certain voltage drop, though u rem ains larger than u_{co} [see Eq. (21) and Fig. 4(b)]. The m otion can start before the stationary tem perature pro le in the static lam ent is established, but the non-m onotonic dynam ics of u rem ains qualitatively the sam e.

D . Self-m otion and self-pinning

As it has been pointed out in Sec. VI, we predict, instead of selfmotion, selfpinning of the lament at its initial location due to the Joule self-heating in the case $\theta_{\rm T} \, f > 0$. For example, it happens when the temperature becomes high enough for them ogeneration to set in. This typically precedes them all destruction of the semiconductor structure due to local overheating. Eq. (20) also suggests an experimental method to distinguish between positive ($\theta_{\rm T} \, f > 0$) and negative ($\theta_{\rm T} \, f < 0$) inuence of temperature on vertical transport by observing the lament dynamics in externally applied temperature gradient: laments move along and against the temperature gradient for $\theta_{\rm T} \, f > 0$ and $\theta_{\rm T} \, f < 0$, respectively.

E. M otion of low-current lam ents

S-shaped current-voltage characteristic exhibits form al duality between high current density and low current density branches. Therefore apart from high-current 1am ents, there are patterns in form of low-current laments: domains of low current density embedded into on state. 5,8 Such lam ents correspond to the upper part of the lam entary current-voltage characteristic (Fig. 1), where average current density is close to J_{on} . In the case θ_T f < 0 low-current lam ents also undergo the bifurcation from static to traveling lam ent. Expressions 20), (21) remain valid as they are, whereas in Eqs. (25), (26) T? and T? should be exchanged. The onset of motion results in the increase, rather than decrease, of the voltage in this case. Duality between on and o states is broken when vertical transport is suppressed near the structure boundary due to a certain process at the lateral edge of the sem iconductor structure, e.g., surface recombination or surface leak in the p-n junction. (This e ect can be m odelled by D irichlet boundary conditions a = 0 im posed on the variable a at x = 0; L_x . In this case the e ect of boundaries can not be neglected for average current densities alose to J_{on} even in the \lim it $L_{\,x}$ current-voltage characteristic, instead of hysteresis, exhibits a continuous crossover from the lam entary branch to the branch of quasiuniform high current density states at high current. Then only high-current laments are observable.

F. Reaction-di usion models for traveling spots

The model (5), (6), (7) belongs to the same class of three-component reaction-di usion models as models for traveling spots in active media discussed in Refs. 45,46, 47,48,49,50. In contrast to the common two-component activator-inhibitor model, 22,31 three-component models are capable to describe localized traveling patterns not only on a one-dimensional spatial domain, but also on spatial domains of higher dimensions. 45,46 The transition

from static to traveling spot takes place with increase of the relaxation time of the rst inhibitor, in the same way as it occurs in the common two-component model of pulse propagation in excitable media. The second fast long-range inhibitor plays an essential role only in the two-dimensional or three-dimensional case: it prevents lateral spreading of the traveling spot which otherwise destroys the spatially localized solution and eventually leads to development of a spiral wave.

This additional inhibition can be either global 45 or local.46 In the rst case the inhibitor has the same value in the whole system. This value depends on the mean value of other dynamical variables in the system and is governed by an integro-di erential equation. This corresponds to the global coupling of a spatially extended nonlinear system. In the second case the additional inhibitor is governed by a conventional reaction-di usion equation. For traveling spots, the di erence between these two cases becomes crucial only when several spots are considered on a two or higher dimensional domain: the system of several spot is unstable when the additional inhibition is global, but becomes stable when it is local.46 This dierence vanishes when only one spot is present, or the spatial domain is one-dimensional.46 G lobal coupling through the gas phase occurs in the surface reactions 51,52,53,54 and can be im plem ented as global feedback loop in the light-sensitive Belousov-Zabotinsky reaction 55,56. Im plem entation of the respective control loop has allowed to observe localized traveling patterns in these system s.54,56

In contrast to the three-component models discussed in Refs. 45,46, in the model (5), (6), (7) both inhibitors are needed for the onset of lam ent motion already in the one-dim ensional case. Consequently, the bifurcation to traveling lament is also dierent. This reects the fact that we start with a stationary pattern in a bistable medium with fast global inhibition (voltage u). This global inhibition is due to the external circuit and represents an inherent feature of spatio-tem poral dynamics of a bistable sem iconductor: For any evolution of the current density pattern which is accompanied by the variation of the total current, the voltage at an external series resistance changes, causing the variation of the voltage across the device. This inhibition is crucial for the existence of current lam ents which become unstable when the global coupling is elim inated by operating the device in the voltage-controlled regim e.2,8,10 The motion of the

lam ent is induced by the e ect of another slow di usive inhibitor (tem perature T). Sim ilar nonlinear mechanism causes the motion of current lam ents obtained by numerical simulations in Refs. 23,47. However, Refs. 23,47 focus on a specietype of multilayer thyristorlike structures. The model of these devices assumes that the second inhibitor is a certain internal voltage, not a temperature.

It is worth to m ention, that self-heating m ay also trigger temporal relaxation-type oscillations of a currentdensity lament. This e ect has been observed in a reversely biased p-i-n diode and is explained by a sim ilar three-component reaction-di usion model.⁵⁷

X. SUMMARY

Joule self-heating of a current density lament in a bistable sem iconductor structure might result in the onset of lateral motion. This occurs when increase of temperature has negative impact on the vertical (cathode-anode) transport. Such negative feedback takes place when bistability of sem iconductor structure is related to the avalanche impact ionization, because the impact ionization rate decreases with temperature. Examples of such devices are avalanche transistors, Reversely biased p-i-n diodes in the regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime, Reversely biased p-i-n diodes in the regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime, Reversely biased p-i-n diodes in the regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime, Reversely biased p-i-n diodes in the regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime, Reversely biased p-i-n diodes in the regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime, Reversely biased p-i-n diodes in the regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime, Reversely biased p-i-n diodes in the regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime of avalanche injection, electrostatic discharge protection devices operated in the avalanche regime of avalanche injection of avalanche regime of avalanche injection of avalanche regime of avalan

Generally, lam ents move against the temperature gradient with a velocity proportional to the tem perature difference at the lam ent edges [Eq. 20)]. In the regime of Joule self-heating the strength of coupling between the master equation (5), which controls the current density dynam ics, and the heat equation (6) can be characterized by single parameter v_0 [Eq. (28)], which has a dimension of velocity. The lament velocity v is determined by the transcendental equation (27). The condition for the spontaneous onset of lam ent motion 29) depends on the ratio of v_{0} and the therm all velocity v_{T} , and on the ratio of the lam ent width W and the therm aldiffusion length 'f. Filam ent motion is never possible for $v_0 < 2v_T$. For $v_0 > 2v_T$, static laments whose width W exceeds a certain threshold W th Eq. (32), curve 1 in Fig. 5] become unstable and start to travel. The lament velocity v and the voltage on the structure u are shown in Fig. 4. For most sem iconductor structures W $< _{\rm T}$, and su ciently far from the bifurcation point $v_0 = 2v_T$ the lam ent velocity can be approxim ated by a truncated version of Eq. (43)

$$v \frac{r}{\frac{W \ v_0}{r}}$$
:

Heating of the static lament is accompanied by an increase of the voltage u Eq. (21)]. With onset of the lament motion the voltage drops, but remains higher than the voltage u_{co} Fig. 4(b)].

Our analytical theory does not cover narrow lam ents, when the at top of current density pro le does not exist or the lam ent width W is comparable to the width of the lam ent wall $\frac{1}{2}$, as well as cylindrical lam ents which appear when lateral dimensions of semiconductor structure L_x and L_y are comparable. However, the bifurcation from static to traveling lam ent and the mechanism of lam ent motion remain qualitatively the same in these

cases.

A cknow ledgm ents

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APPENDIX: SOLUTIONS OF THE HEAT EOUATION

A ssum ing that the front walls are thin, we present Eq. (13) as (see Fig. 2):

$$v_{T}^{2} T^{0} + v_{T} T^{0} + (T^{?} T) = 0$$
 (A.1)
for $\frac{W}{2} < \frac{W}{2}$;
 $v_{T}^{2} T^{0} + v_{T} T^{0} + (T_{?} T) = 0$
for $\frac{W}{2}$ and $\frac{W}{2}$:

Here the middle of the lament is at = 0. To and T? are de ned by Eqs. 16), (24). The solution of this piecew is linear equation is given by

$$T() = T_{?} (T^{?} T_{?}) \qquad (A 2)$$

$$\frac{2^{+}}{+} \sinh \frac{W}{2} \exp()$$
for $> \frac{W}{2};$

$$T() = T^{?} \frac{T^{?} T_{?}}{+} + \exp + \frac{W}{2}$$

$$\exp^{-+} \frac{W}{2}$$
for $\frac{W}{2} < < \frac{W}{2};$

$$T() = T_{?} (T^{?} T_{?})$$

$$\frac{2}{+} \sinh \frac{+W}{2} \exp(^{+})$$
for $< \frac{W}{2};$

where + and are eigenvalues of Eq. (A.1):

$$= \frac{2 s}{\frac{1}{r}} \frac{4}{4} \frac{1}{1} + \frac{v}{2v_{T}}^{2} + \frac{v}{2v_{T}}^{5} :$$

Eqs. (A 2) allow to determ ine the tem perature di erence ($T_L + T_R$) and the m ean tem perature ($T_L + T_R$)=2 Eqs. (23), (25), (26)] which are needed for self-consistent calculation of the front velocity v and the voltage u.

Steady tem perature pro le. For v = 0 we get $^+ = 1 = i_T$ and the corresponding sym m etric tem perature pro le is given by

Tem perature pro le in the fast lament. For v_T we get $^+$ = $(v_T)^{-1}$, = 1. The corresponding pro le is strongly asymmetric:

$$T() = T_{?}$$
 for $> \frac{W}{2}$; (A.5)
 $T() = T^{?}$ $(T^{?} T_{?}) \exp \frac{2 W}{2V_{T}}$
for $\frac{W}{2} < < \frac{W}{2}$;
 $T() = T_{?} + 2(T^{?} T_{?}) \sinh \frac{W}{2V_{T}} \exp \frac{V_{T}}{V_{T}}$

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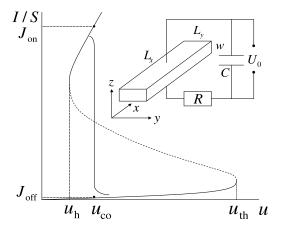


FIG. 1: Current-voltage characteristic of a bistable structure. The average current density I=S is shown, where $S = L_x L_y$ is the cross-section of the structure. Unstable middle branch with negative dierential conductance is depicted by the dashed line. The hold and threshold voltages are denoted as u_h and u_{th} , respectively. The vertical branch at $u = u_{co}$ corresponds to a static lament. The inset shows a sketch of a bistable semiconductor structure operated in the external circuit with load resistance R, capacitance C, and bias U_0 .

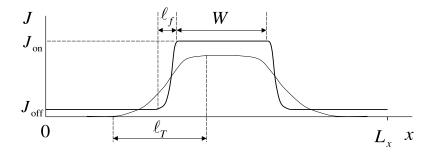


FIG. 2: Current density pro le in a lam ent (thick line). Thin line denotes the tem perature pro le in the static lam ent.

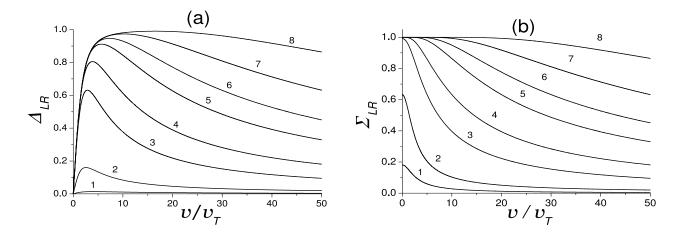


FIG. 3: The norm alized difference $_{LR}$ (a) and the sum $_{LR}$ (b) of the temperatures in the lament walls T_L and T_R as functions of the lament velocity v for different lament widths W. $_{LR}$ and $_{LR}$ are defined by Eqs. (23), (25), (26). Curves 1 to 8 correspond to $W = Y_T = 0.2;1;5;10;20;30;50;100$, respectively.

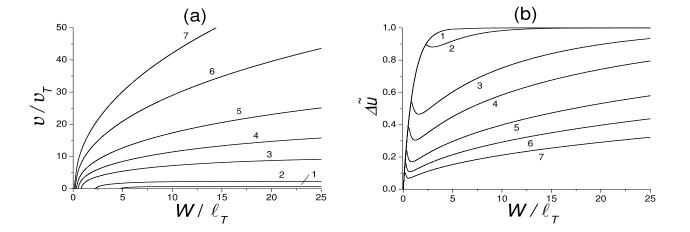


FIG. 4: The lam ent velocity v (a) and normalized voltage on the structure v (b) as functions of the lam ent width W for dierent values of the parameter v_0 . v is defined by Eq. (30). Curves 1 to 7 correspond to $v_0 = 2:1;3;10;20;50;100;200$, respectively. Peaks on the voltage curves are related to onset of the lam ent motion.

